

CHIP ELECTRONIC COMPONENTABSTRACT OF THE DISCLOSURE

A chip electronic component including a ceramic element and terminal electrodes with metal coating thereon formed on the surface of the ceramic element. A glass layer is formed on a part of the surface of the ceramic element where the terminal electrodes are not formed. A glass material for the glass layer contains at least two species of alkali metal elements selected from Li, Na and K, and the total amount of the alkali metal elements is greater than or equal to 20 atomic percent of the total amount of elements except oxygen contained in the glass material.